IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chopra et al.

Serial No.: 10/620,002

Filed: July 14, 2003

FOR: SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND A COPPER

BARRIER (as amended)

Confirmation No.: 7481

Examiner: L. Vinh

Group Art Unit: 1792

Attorney Docket No.: 2269-4373.2US

(2000-0036.02/US)

VIA ELECTRONIC FILING November 5, 2008

AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Examiner:

This Amendment follows the Office Action of August 5, 2008, the shortened statutory period for response to which expires on November 5, 2008.

A listing of claims, in which revisions to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 6 of this paper.